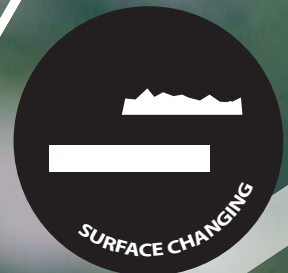
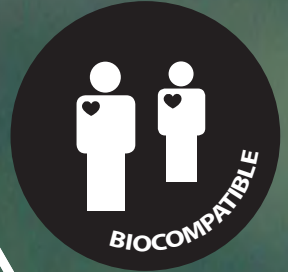


# Parylene-coatings



CH<sub>2</sub>

CH<sub>2</sub>

Cl

electronic  
**diener**

Plasma-Surface-Technology



Raw material - Dimer powder

### What are parylene coatings:

Parylene is the abbreviation for the polymer group named poly (**para-xylylene**). These polymers consist of differently substituted para-xylylenes. The initial state for the coating is given by the so-called **dimers**. A dimer is a molecule composite which consists of two identical subunits, namely the monomers.

### Advantages and properties:

Parylene coatings offer a wide range of benefits. Parylene coatings ...

- are perfectly **conformal**: that means that the coating is adapting also on complex substrate contours such as sharp edges or holes.
- are „**pinhole-free**“, starting at layer thicknesses of about 0.5 microns.
- are **chemically insoluble** and **resistant** to a wide range of chemicals.
- exhibit **very good barrier properties** to moisture and chemicals.
- own a **high dielectric strength**.
- possess dry lubricating film properties (low friction coefficient).
- are **hydrophobic** - contact angle of H<sub>2</sub>O between 92 ° and 98 °.
- are **transparent** between 90 and 96 % in the range of the visible wavelength (depending on the type of parylene).
- are **biocompatible** - The parylene types C and N can be certified according to USP Class VI, ISO 10993 and FDA.

### Parylene Types:

#### Parylene N

- Basic type - consisting only of atoms of hydrogen and carbon and is therefore halogen-free
- Very good crack penetration.
- Very good dielectric properties and dielectric strength (low dielectric constant)
- Lowest friction coefficient\*, often used for equipment of minimal invasive surgery



Parylene peeled-off from a mirror

- FDA approval
- Long-term temperature resistance\*\*: 60 ° C

#### Parylene C:

- One chlorine atom on the aromatic ring
- Most common parylene type.
- Lowest permeability of humidity (H<sub>2</sub>O) and other gases and thus excellent barrier properties and good corrosion protection.
- Relatively high deposition rate, thus the most economical deposition process.
- Good mechanical properties
- FDA approval
- Long-term temperature resistance\*\*: 80 ° C

#### Parylene D

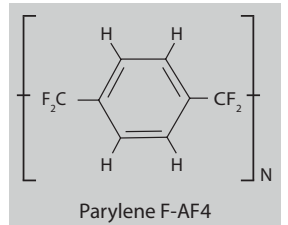
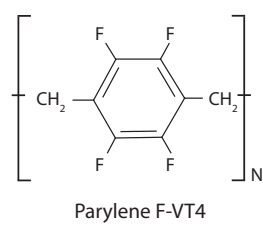
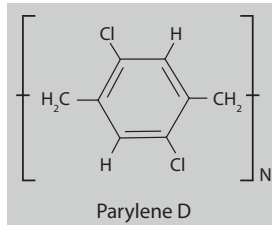
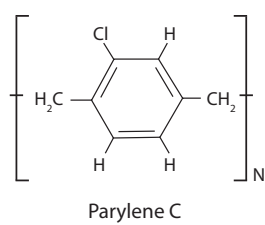
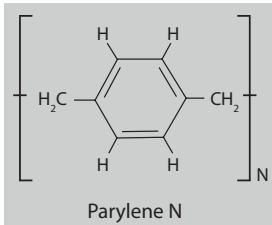
- Two chlorine atoms on the aromatic ring
- Good mechanical properties
- Low permeability of humidity (H<sub>2</sub>O) and other gases
- Highest temperature resistance of chlorinated types
- Long-term temperature resistance\*\*: 100 ° C

#### Parylene F-VT4:

- Four fluorine atoms on the aromatic ring
- Since thermally even higher loads than Parylene D, it displaces this increasingly







### Monomer units of the most common parylene types

- Good dielectric properties
- Good crack penetration
- Long-term temperature resistance\*\*: 200 °C
- 

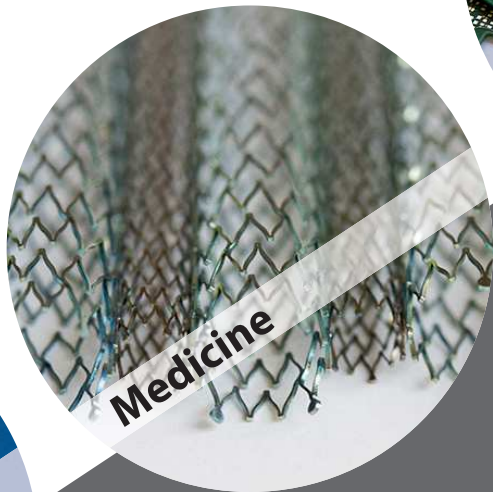
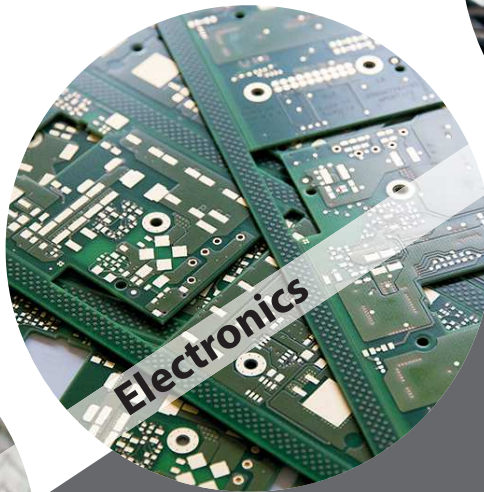
- The most expensive version, therefore only used when these special properties are necessarily required.

\* On steel without lubrication

\*\* 11,4 years

#### Parylene F-AF4:

- Four fluorine atoms on the aliphatic groups
- Best crack penetration.
- By far the highest temperature resistance of all Parylene types - up to 350 °C long-term temperature stable\*\*.
- Resistant to UV radiation
- Very low coefficient of friction\*
- FDA approval
- Excellent dielectric properties and dielectric strength (low dielectric constant)



#### Applications:

##### Electronics

- PCBs
- All kinds of sensors
- Semiconductor devices
- Ferrite cores
- Permanent magnets - rare earth magnets

##### Medical Devices

- Cannulas, catheters
- Biopsy needles
- Probes and endoscopes
- Ampoules / bags
- Hearing Aids
- Implants, corona stents

##### Aerospace

- Navigation Electronics / flight control systems
- Cockpit instrumentation
- Communication Technology
- Satellite Electronics / imaging equipment
- Radar / detectors

##### Automotive

- Pressure Sensors / Flow Sensors / Emission Sensors
- Engine electronics / control unit
- Rotors / stators / motors
- Monitoring and control systems
- Battery / Cell Systems
- Radar / detectors

##### LEDs

- Electronic billboards
- Aviation / Automotive Lighting
- Outdoor lighting
- Traffic lights

##### Industrie

- Seals
- O-rings
- Pipes
- Bottles / containers

| Property                        | Unit                   | Parylene N          | Parylene C                     | Parylene D                   | Parylene F-VT4                                                                                    | Parylene F-AF4                                                                                        |
|---------------------------------|------------------------|---------------------|--------------------------------|------------------------------|---------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|
|                                 |                        | Poly(para-xylylene) | Poly(monochloro-para-xylylene) | Poly(dichloro-para-xylylene) | Poly(tetrafluoro-para-xylylene) F-VT4: Substitution of 4 H atoms by 4 F atoms on the benzene ring | Poly(tetrafluoro-para-xylylene) F-AF4: Substitution of 4 H atoms by 4 F atoms on the aliphatic groups |
| Density                         | [g/cm <sup>3</sup> ]   | 1,11                | 1,29                           | 1,42                         | ~1,6                                                                                              | ~1,51                                                                                                 |
| Refractive index                | [ ]                    | 1,66                | 1,64                           | 1,67                         | 1,57                                                                                              | 1,56                                                                                                  |
| Tensile Modulus                 | [GPa]                  | 2,4                 | 3,2                            | 2,8                          | 3,0                                                                                               | 2,6                                                                                                   |
| Yield Strength                  | [MPa]                  | 42                  | 55                             | 60                           | 52                                                                                                | 35                                                                                                    |
| Tensile Strength                | [MPa]                  | 45                  | 70                             | 75                           | 55                                                                                                | 52                                                                                                    |
| Hardness, Rockwell R            | [GPa]                  | 85                  | 80                             | 80                           | -                                                                                                 | 122                                                                                                   |
| Yield Elongation                | [%]                    | 2,5                 | 2,9                            | 3,0                          | 2,5                                                                                               | 2,0                                                                                                   |
| Elongation to break             | [%]                    | 30                  | 200                            | 10                           | 10-50                                                                                             | 10                                                                                                    |
| Static coefficient of friction  | [ ]                    | 0,25                | 0,29                           | 0,35                         | 0,39                                                                                              | 0,15                                                                                                  |
| Dynamic coefficient of friction | [ ]                    | 0,25                | 0,29                           | 0,31                         | 0,35                                                                                              | 0,13                                                                                                  |
| Durable Heat Resistance         | [°C]                   | 60                  | 80                             | 100                          | 200                                                                                               | 350                                                                                                   |
| Temporary peak temperature      | [°C]                   | 95                  | 115                            | 135                          | 250                                                                                               | 450                                                                                                   |
| Melting point                   | [°C]                   | 420                 | 290                            | 380                          | -                                                                                                 | ≤ 500                                                                                                 |
| Dielectric constant (1 MHz)     | [ ]                    | 2,66                | 2,95                           | 2,80                         | 2,35                                                                                              | 2,17                                                                                                  |
| Dissipation Factor (1 MHz)      | [ ]                    | 0,001               | 0,013                          | 0,002                        | 0,008                                                                                             | 0,002                                                                                                 |
| Dielectric strength             | [MV/cm]                | 300                 | 185-220                        | 215                          | -                                                                                                 | 225                                                                                                   |
| Volume resistivity              | [23 °C, 50 %RH, Ω·cm ] | 1,4E+17             | 8,8E+16                        | 2,0E+16                      | 1,1E+17                                                                                           | 2,0E+17                                                                                               |
| Surface resistivity             | [23 °C, 50 %RH, Ω]     | 1,0E+13             | 1,0E+14                        | 5,0E+16                      | 4,7E+17                                                                                           | 5,0E+15                                                                                               |
| Linear coefficient of expansion | [µm/m·°C]              | 69                  | 35                             | 38                           | -                                                                                                 | 36                                                                                                    |
| Heat capacity                   | [25 °C, J/(g·K)]       | 1,3                 | 1,0                            | 0,8                          | -                                                                                                 | 1,0                                                                                                   |
| Thermal conductivity            | [W/m·K]                | 0,13                | 0,08                           | -                            | -                                                                                                 | 0,10                                                                                                  |

[1] W. Beach, C. Lee, and D. Bassett, Encyclopedia of Polymer Science and Engineering (Wiley, New York, 1985), 17, 990

[2] J.B. Fortin, Poly-para-xylylene Thin Films: A Study of the Deposition Chemistry, Kinetics, Film Properties, and Film Stability, Ph.D. Thesis, rensseleer Polytechnic Institute, 2001

[3] F. E. Cariou, D.J. Vally, and W.E. Loeb, IEEE Transactions on Biomedical Engineering 33(2), 202 (1992).

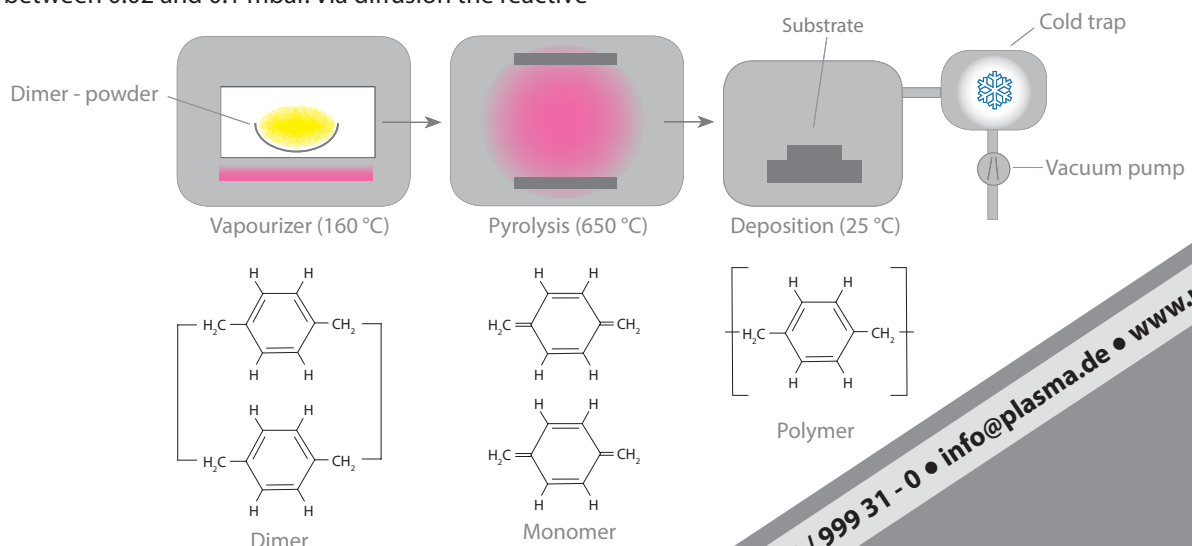
[4] Structural and dielectric properties of parylene-VT4 thin films Article (PDF Available) in Materials Chemistry and Physics 143(3):908–914 · February 2014 with 71 Reads

[5] Angaben aus www.matweb.com Material Property Data

### Process description:

The deposition takes place by **polymerization** through a vacuum assisted coating process, the so-called **chemical vapor deposition – CVD**. The **“dimer”** (solid [2,2]-p-cyclophane), which is present in a powder-like shape, will be **sublimated** within the the **vapourizer**. The **thermal decomposition** of the relatively inert „dimer-gas“ is carried out using a **pyrolysis tube** with temperatures of about 650 °C, resulting in the formation of highly reactive monomers. The process pressure is dependent on the used dimer-type and the dimensions/ construction of the deposition system - common values are between 0.02 and 0.1 mbar. Via diffusion the reactive

monomers enter into the vacuum chamber in which the coating material is placed on a rotating frame. The **reactive monomers** preferably **polymerize** on cold surfaces, and form a thin layer of poly(para-xylylene) or rather **Parylene**. Since not all of the monomers polymerize inside the chamber, it is necessary to work with a **cold trap** which is installed behind the chamber to avoid a coating/damage of the vacuum pump. During the process, the trap can be easily filled with **liquid nitrogen**, so that the residual monomers will polymerize in the cold trap.



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